

Pro/E

PDM: Rev:©

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PRODUCT NUMBER

5|863-00|__ NOTE: 2

CONNECTOR NOTES:

I. HOUSING MATERIAL: UL 94 V-O GLASS FILLED HIGH-TEMP THERMOPLASTIC POWER CONTACT MATERIAL: COPPER ALLOY SIGNAL PIN MATERIAL: COPPER ALLOY

PCB NOTES:

- 3. ALL DIMENSIONS ARE BASIC UNLESS OTHERWISE SPECIFIED.
- 4. ALL THROUGH HOLES ARE LOCATED WITH A TRUE POSITION OF 0.004 [0.10]
- 5. ALL HOLE DIAMETERS ARE FINISHED HOLE SIZE
- 6. Ø 0.098 [2.49] THROUGH HOLES ARE UNPLATED
- 7. \emptyset 0.0453 \pm 0.0010 [1.151 \pm 0.025] DRILLED HOLES PLATED WITH 0.0003 [0.008] MIN SnPb OVER 0.001 [0.03] TO 0.003 [0.08] Cu PLATING TO ACHIEVE A \emptyset 0.040 \pm 0.003 [1.02 \pm 0.07] HOLE.
- 8. ACSYMBOL WILL BE NEXT TO ANY DIMENSION, VIEW, OR NOTE WHICH HAS BEEN MODIFIED WITH THE CURRENT DRAWING REVISION.

CONFIDENTIAL

mat'l code NOTE I					tolerances unless otherwise specified					CUSTOMER F				FC	;) <u>,</u>						
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STATUS: Released Printed: Sep 21, 2008